New Jersey Semi-Conductor Products, Inc.

20 STERN AVE.
SPRINGFIELD, NEW JERSEY 07081
U.S.A.

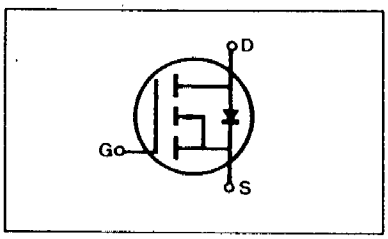
TELEPHONE: (973) 376-2922
(212) 227-6005
FAX: (973) 376-8960

IRF9240/9241/9242/9243
IRFP9240/9241/9242/9243
IRF9640/9641/9642/9643

P-CHANNEL POWER MOSFETS

Preliminary Specifications

–200 Volt, 0.5 Ohm SFET



PRODUCT SUMMARY

Part Number	V_{DS}	$R_{DS(on)}$	I_D
IRF/IRFP9240, IRF9640	–200V	0.5Ω	–11A
IRF/IRFP9241, IRF9641	–150V	0.5Ω	–11A
IRF/IRFP9242, IRF9642	–200V	0.7Ω	–9.0A
IRF/IRFP9243, IRF9643	–150V	0.7Ω	–9.0A

FEATURES

- **Low $R_{DS(on)}$**
- **Improved inductive ruggedness**
- **Fast switching times**
- **Rugged polysilicon gate cell structure**
- **Low input capacitance**
- **Extended safe operating area**
- **Improved high temperature reliability**

PACKAGE STYLE

Package Type	Part Number
TO-3	IRF9240/9241/9242/9243
TO-3P	IRFP9240/9241/9242/9243
TO-220	IRF9640/9641/9642/9643

MAXIMUM RATINGS

Characteristic	Symbol	IRF/IRFP 9240 9640	9241 9641	9242 9642	9243 9643	Unit
Drain-Source Voltage (1)	V_{DSS}	–200	–150	–200	–150	Vdc
Drain-Gate Voltage (R_{GS}=1.0MΩ) (1)	V_{DGR}	–200	–150	–200	–150	Vdc
Gate-Source Voltage	V_{GS}	±20				Vdc
Continuous Drain Current T_C=25°C	I_D	–11	–11	–9.0	–9.0	Adc
Continuous Drain Current T_C=100°C	I_D	–7.0	–7.0	–6.0	–6.0	Adc
Drain Current—Pulsed (3)	I_{DM}	–44	–44	–36	–36	Adc
Gate Current—Pulsed	I_{GM}	±1.5				Adc
Total Power Dissipation @ T_C=25°C Derate above 25°C	P_D	125 1.0				Watts W/°C
Operating and Storage Junction Temperature Rangy	T_J, Tstg	–55 to 150				°C
Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	T_L	300				°C

Notes: (1) T_J=25°C to 150°C
(2) Pulse test: Pulse width≤300μs, Duty Cycle≤2%
(3) Repetitive rating: Pulse width limited by max. junction temperature

ELECTRICAL CHARACTERISTICS (T_C=25°C unless otherwise specified)

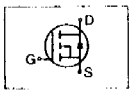
Characteristic	Symbol	Type	Min	Typ	Max	Units	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	IRF9240/2 IRFP9240/2 IRF9640/2	−200	—	—	V	V_{GS}=0V
		IRF9241/3 IRFP9241/3 IRF9641/3	−150	—	—	V	I_D=−250μA
Gate Threshold Voltage	$V_{GS(th)}$	ALL	−2.0	—	−4.0	V	V_{DS}=V_{GS}, I_D=−250μA
Gate-Source Leakage Forward	I_{GSS}	ALL	—	—	−100	nA	V_{GS}=−20V
Gate-Source Leakage Reverse	I_{GSS}	ALL	—	—	100	nA	V_{GS}=20V
Zero Gate Voltage Drain Current	I_{DSS}	ALL	—	—	−250	μA	V_{DS}=Max. Rating, V_{GS}=0V
			—	—	−1000	μA	V_{DS}=Max. Rating×0.8, V_{GS}=0V, T_C=125°C
On-State Drain-Source Current (2)	$I_{D(on)}$	IRF9240/1 IRFP9240/1 IRF9640/1	−11	—	—	A	V_{DS}>$I_{D(on)}$×$R_{DS(on)\ max.}$, V_{GS}=−10V
		IRF9642 IRF9643	−9.0	—	—	A	
Static Drain-Source On-State Resistance (2)	$R_{DS(on)}$	IRF9240/1 IRFP9240/1 IRF9640/1	—	—	0.5	Ω	V_{GS}=−10V, I_D=−6.0A
		IRF9242/3 IRFP9242/3 IRF9642/3	—	—	0.7	Ω	
Forward Transconductance (2)	g_{fs}	ALL	4.0	—	—	Ʊ	V_{DS}>$I_{D(on)}$×$R_{DS(on)\ max.}$, I_D=−6.0A
Input Capacitance	C_{iss}	ALL	—	—	1300	pF	V_{GS}=0V, V_{DS}=−25V, f=1.0MHz
Output Capacitance	C_{oss}	ALL	—	—	450	pF	
Reverse Transfer Capacitance	C_{rss}	ALL	—	—	250	pF	
Turn-On Delay Time	$t_{d(on)}$	ALL	—	—	30	ns	V_{DD}=0.5BV_{DSS}, I_D=−6.0A, Z_O=4.7Ω, (MOSFET switching times are essentially independent of operating temperature.)
Rise Time	t_r	ALL	—	—	15	ns	
Turn-Off Delay Time	$t_{d(off)}$	ALL	—	—	18	ns	
Fall Time	t_f	ALL	—	—	12	ns	
Total Gate Charge (Gate-Source Plus Gate-Drain)	Q_g	ALL	—	—	90	nC	V_{GS}=−15V, I_D=−22A, V_{DS}=0.8 Max. Rating (Gate charge is essentially independent of operating temperature.)
Gate-Source Charge	Q_{gs}	ALL	—	—	30	nC	
Gate-Drain ("Miller") Charge	Q_{gd}	ALL	—	—	60	nC	

THERMAL RESISTANCE

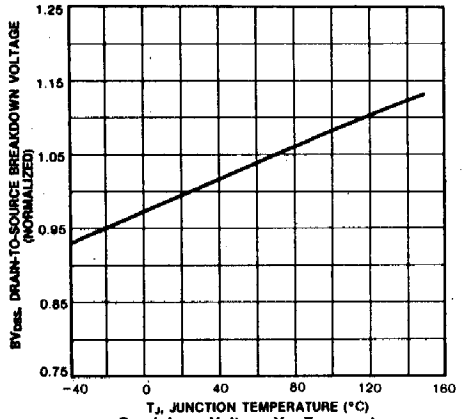
Junction-to-Case	R_{thJC}	ALL	—	—	1.0	K/W	
Case-to-Sink	R_{thCS}	ALL	—	1.0	—	K/W	Mounting surface flat, smooth, and greased
Junction-to-Ambient	R_{thJA}	IRFPXXXX IRF96XX	—	—	80	K/W	Free Air Operation
		IRF92XX	—	—	30	K/W	

Notes: (1) T_J=25°C to 150°C
(2) Pulse test: Pulse width≤300μs, Duty Cycle≤2%
(3) Repetitive rating: Pulse width limited by max. junction temperature

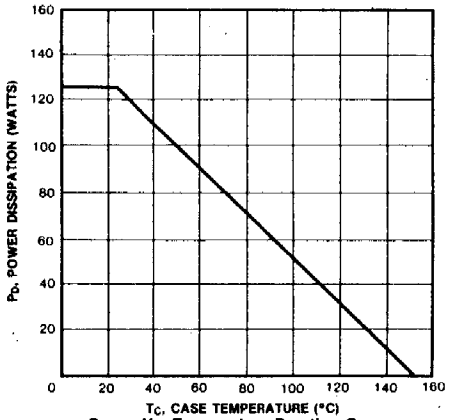
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristic	Symbol	Type	Min	Typ	Max	Units	Test Conditions
Continuous Source Current (Body Diode)	I_S	IRF9240/1 IRFP9240/1 IRF9640/1	—	—	−11	A	Modified MOSFET symbol showing the integral reverse P-N junction rectifier 
		IRF9242/3 IRFP9242/3 IRF9642/3	—	—	−9.0	A	
Pulse Source Current (Body Diode) (3)	I_{SM}	IRF9240/1 IRFP9240/1 IRF9640/1	—	—	−44	A	
		IRF9242/3 IRFP9242/3 IRF9642/3	—	—	−36	A	
Diode Forward Voltage (2)	V_{SD}	IRF9240/1 IRFP9240/1 IRF9640/1	—	—	−4.6	V	T_C=25°C, I_S=−11A, V_{GS}=0V
		IRF9242/3 IRFP9242/3 IRF9642/3	—	—	−4.4	V	T_C=25°C, I_S=−9.0A, V_{GS}=0V
Reverse Recovery Time	t_{rr}	ALL	—	—	—	ns	T_J=150°C, I_F=−11A, dI_F/dt=100A/μs

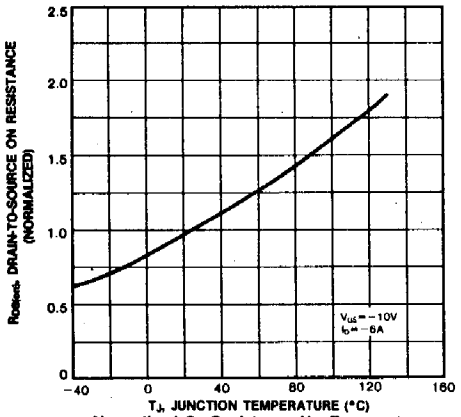
Notes: (1) T_J=25°C to 150°C (2) Pulse test: Pulse width≤300μs, Duty Cycle≤2%
(3) Repetitive rating: Pulse width limited by max. junction temperature



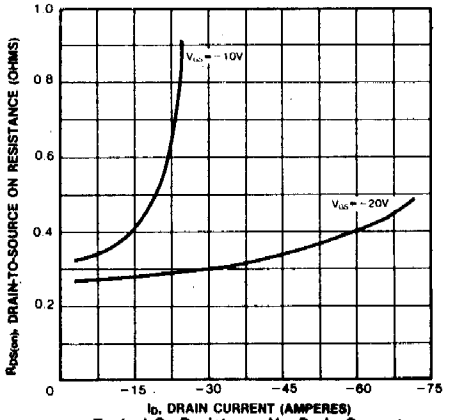
Breakdown Voltage Vs. Temperature



Power Vs. Temperature Derating Curve

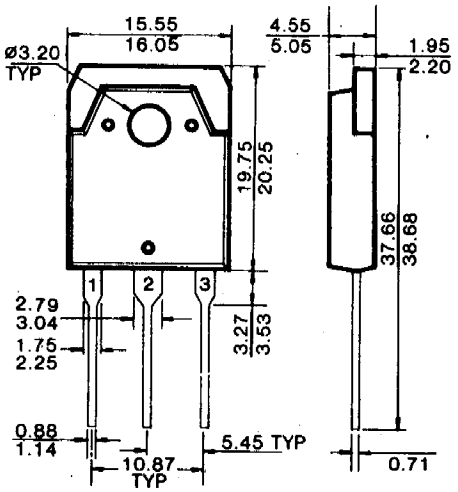


Normalized On-Resistance Vs. Temperature



Typical On-Resistance Vs. Drain Current

TO-3P **Unit: mm**



1. Gate 2. Drain 3. Source